

# LNJ853W86RA

## High Bright Surface Mounting Chip LED

SV (Side View) -0.5 Type

■ Absolute Maximum Ratings  $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Power dissipation	$P_D$	55	mW
Forward current	$I_F$	20	mA
Pulse forward current *	$I_{FP}$	60	mA
Reverse voltage	$V_R$	4	V
Operating ambient temperature	$T_{opr}$	-30 to +85	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-40 to +100	$^\circ\text{C}$

■ Lighting Color

- Soft Orange

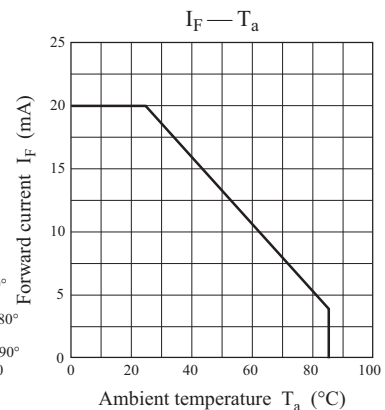
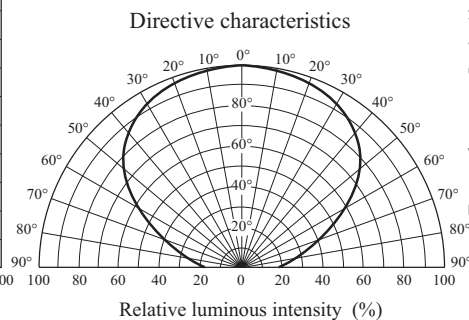
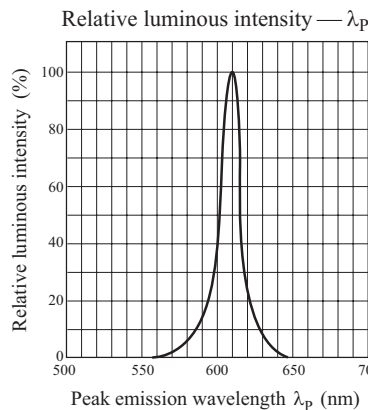
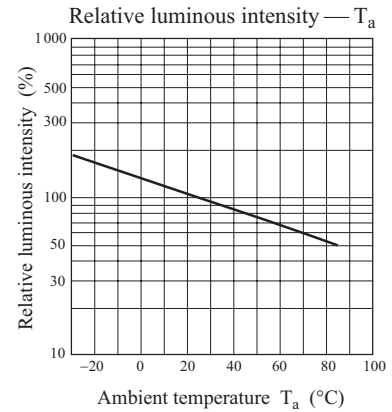
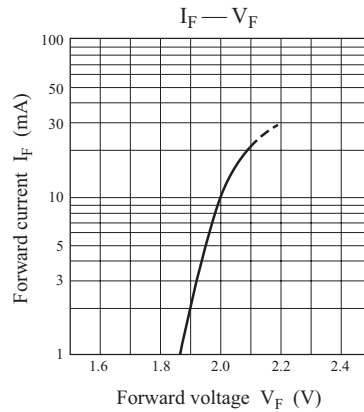
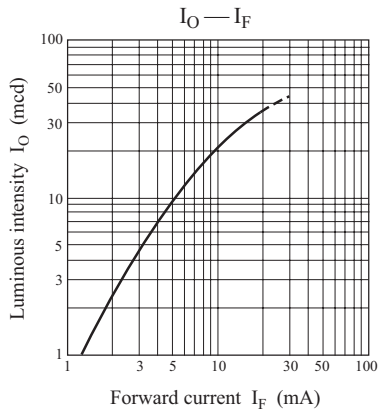
Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

■ Electro-Optical Characteristics  $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity *1	$I_O$	$I_F = 5 \text{ mA}$	7.0	9.0	23.0	mcd
Reverse current	$I_R$	$V_R = 4 \text{ V}$			100	$\mu\text{A}$
Forward voltage	$V_F$	$I_F = 5 \text{ mA}$		1.95	2.30	V
Peak emission wavelength	$\lambda_p$	$I_F = 5 \text{ mA}$		610		nm
Dominant emission wavelength *2	$\lambda_d$	$I_F = 5 \text{ mA}$	597	605	610	nm
Spectral half band width	$\Delta\lambda$	$I_F = 5 \text{ mA}$		15		nm

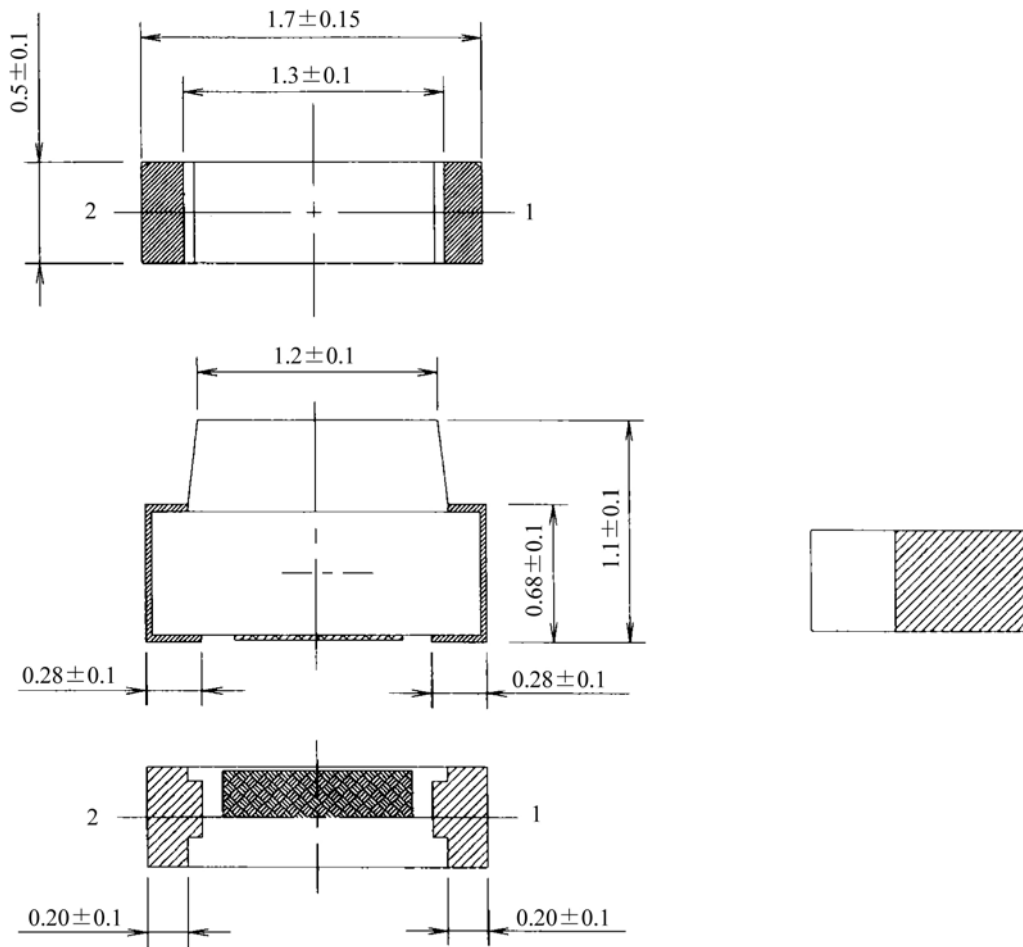
Note) \*1: Measurement tolerance:  $\pm 20\%$

\*2: Measurement tolerance:  $\pm 2 \text{ nm}$



■ Package (Unit: mm)

**KLTF5N2K5300**



- Pin name  
 1: Anode  
 2: Cathode

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